

Crystal LTD TM SPEC Form

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Customer

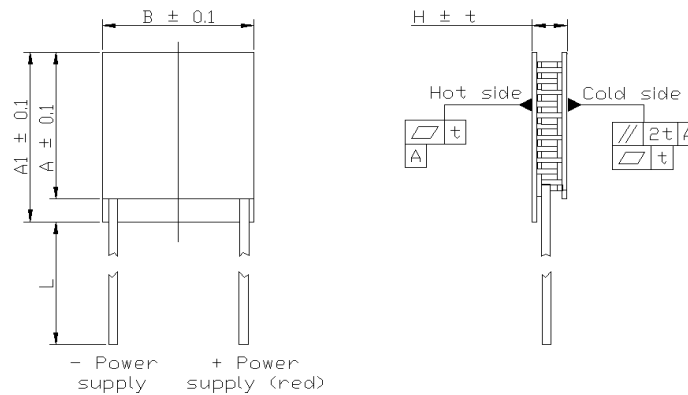
PO#

PO date

Thermoelectric module (TM) specification

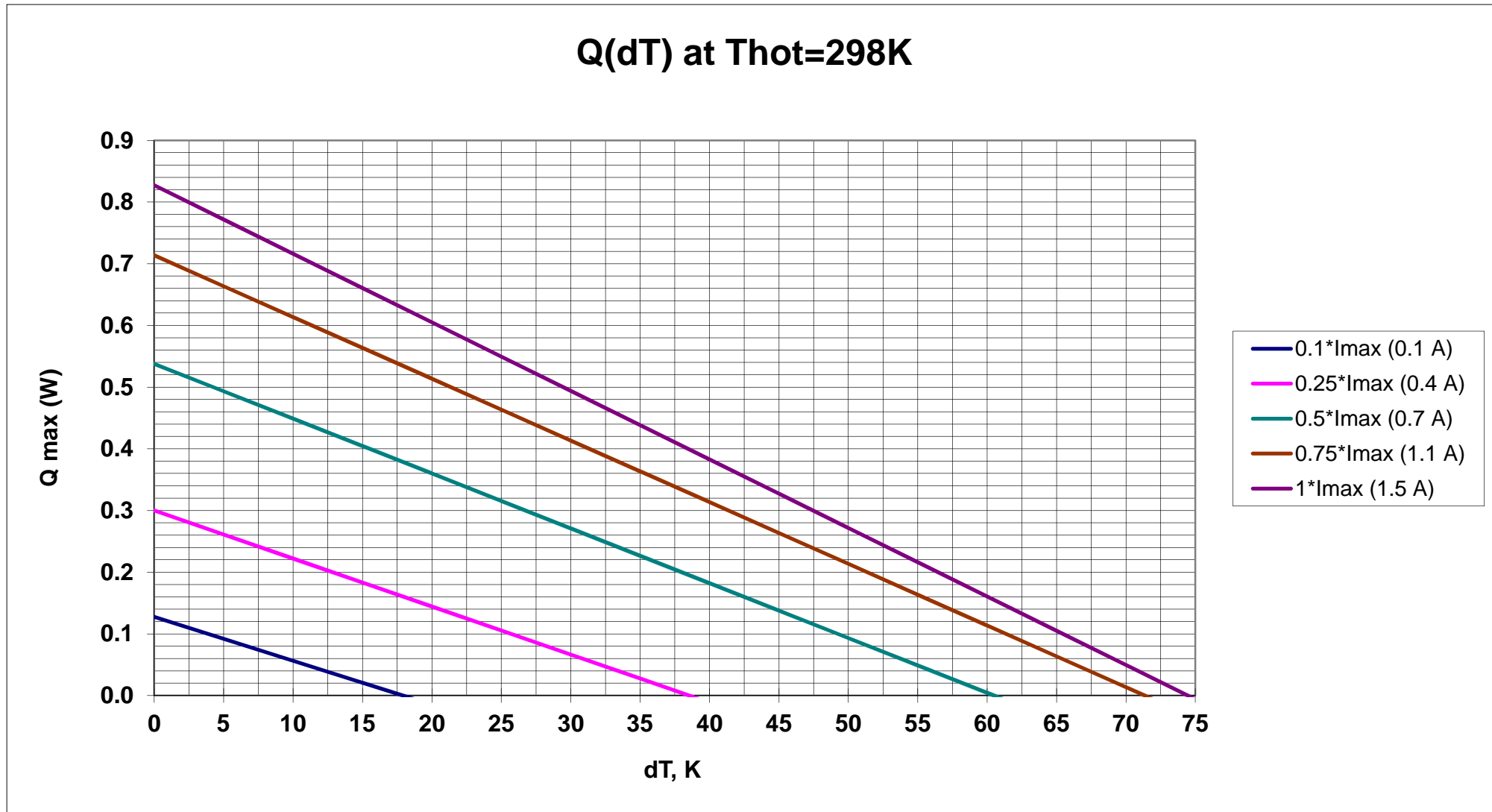
PO position #	TM	Internal Solder Melting Temp, C	Max operating temperature, °C		Parameters in vacuum at hot side temperature 25 °C				Rac at 25 °C		Ceramic size, mm		TM Height		Wire			Sealing
			short peak	continuous operation	I _{max} , A	U _{max} , V	Q _{max} , W	dT _{max} , K	R _{ac} , Ohm	Tolerance ±, %	A/A1	B	Height, mm	Tolerance t, ± mm	S, mm ²	Length, mm	Tolerance ±, mm	
1	S-007-07-15	138	130	115	1.5	0.9	0.8	74.5	0.45	10	6/6	6	2.90	0.2	0.12	100	1	
															MGTF (teflon)			
															or			
															30AWG solid tinned uninsulated			

Clamping force: 0.1 - 0.8 kg



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Max dT is reduced by 2-3K for silicon sealed and 1-2K for epoxy sealed versions.



U(dT) at $T_{hot}=298K$

